

THIS REGISTERED OUTLINE HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE, AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY, CHANGES ARE LIKELY TO OCCUR.

JEDEC	TITLE: R-MSFM-X3	ISSUE:	DATE:	ITEM	PAGE
SOLID STATE PRODUCT OUTLINE	HERMETIC FLANGE MOUNTED HEADER FAMILY (PERIPHERAL TERMINALS) THREE LEAD, 5.0 SPACING	A	9-94	TO-267	1 OF 2

S Y		VARIATIONS				
M B		AA				
0 L	MIN	MOM	MAX			
A	6.60	7.00	7.40			
A1	1.25	1.50	1.80			
A2		4.00 BSC.				
Øb	1.40	1.50	1.65			
D	23.60	23.90	24.15			
D1	16.40	16.65	16.90			
D2	0.00	0.00	2.35			
е		5.0 BSC.				
E	20.20	20.30	20.45			
L	12.70	15.90	19.05			
L1	19.80	20.20	20.60			
ØP	3.95	4.05	4.20			
NOTE	1, 2, 3,					
REF	ITEM 10-349					
ISSUE	А					

NOTES:

- 1. REFER TO APPLICABLE SYMBOL LIST.
- 2. DIMENSIONS AND TOLERANCING PER ANSI Y14.5.M. 1982.
- 3. CONTROLLING DIMENSION: MILLIMETERS.

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